

### Features

- Ultra low capacitance: 0.3pF(IO to IO)
- Ultra low leakage: nA level
- Low operating voltage: 5V
- Low clamping voltage
- Protects one power line and four data lines
- Flow-through package
- Complies with following standards:
  - IEC 61000-4-2 (ESD) immunity test  
Air discharge:  $\pm 25\text{kV}$   
Contact discharge:  $\pm 20\text{kV}$
  - IEC61000-4-4 (EFT) 40A (5/50ns)
  - IEC61000-4-5 (Lightning) 5A (8/20 $\mu\text{s}$ )
- RoHS Compliant

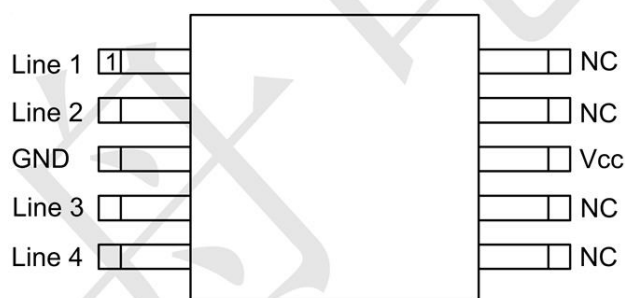
### Mechanical Characteristics

- Package: MSOP-10
- Lead Finish: Matte Tin
- Case Material: "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Shipping Qty :3000pcs/13Inch Tape & Reel

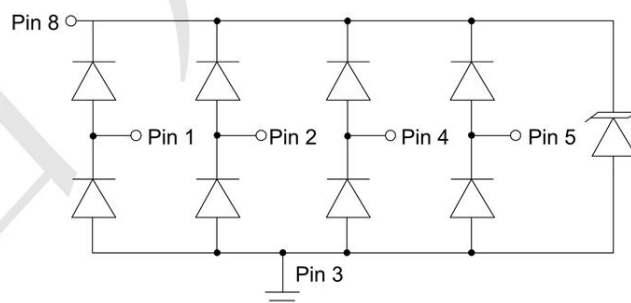
### Applications

- DVI Ports
- HDMI Ports
- Set Top Box
- Projection TV
- Notebook Computers
- 10/100/1000 Ethernet

### Dimensions and Pin Configuration



**Marking: 544M**



### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise specified)

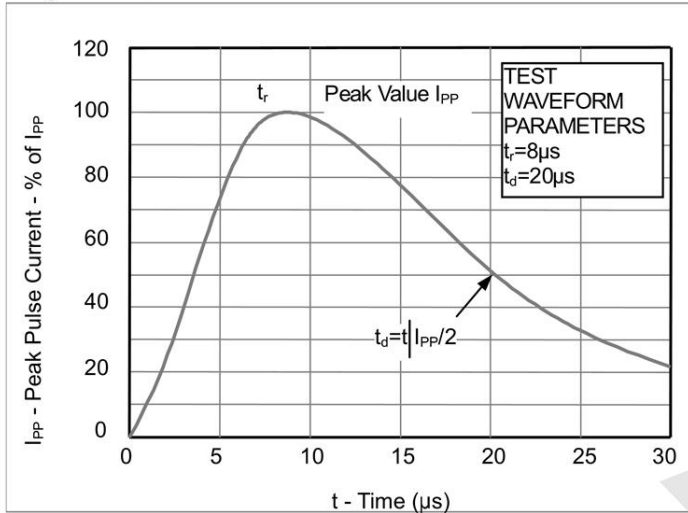
Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 $\mu\text{s}$ )	Ppk	100	W
Peak Pulse Current (8/20 $\mu\text{s}$ )	I <sub>PP</sub>	5	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V <sub>ESD</sub>	$\pm 25$ $\pm 20$	kV
Operating Temperature Range	T <sub>J</sub>	-55 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C

### Electrical Characteristics ( $T_A=25^\circ\text{C}$ unless otherwise specified)

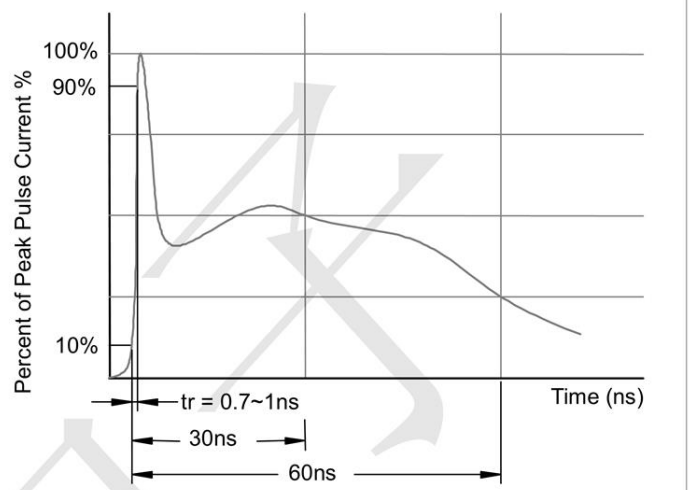
Parameter	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Working Voltage	V <sub>RWM</sub>			5	V	Any I/O pin to ground
Breakdown Voltage	V <sub>BR</sub>	6			V	I <sub>T</sub> = 1mA, any I/O pin to ground
Reverse Leakage Current	I <sub>R</sub>			1	$\mu\text{A}$	V <sub>RWM</sub> = 5V, any I/O pin to ground
Clamping Voltage	V <sub>C</sub>			14	V	I <sub>PP</sub> = 1A (8 x 20 $\mu\text{s}$ pulse), any I/O pin to ground
Clamping Voltage	V <sub>C</sub>			20	V	I <sub>PP</sub> = 5A (8 x 20 $\mu\text{s}$ pulse), any I/O pin to ground
Junction Capacitance	C <sub>J</sub>		0.7	1	pF	V <sub>R</sub> = 0V, f = 1MHz, any I/O pin to ground
Junction Capacitance	C <sub>J</sub>		0.3	0.6	pF	V <sub>R</sub> = 0V, f = 1MHz, between I/O pins

**Typical Performance Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise Specified)**

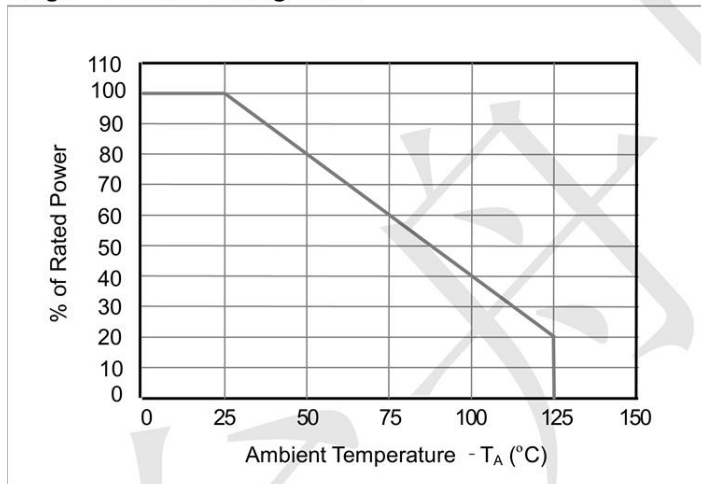
**Fig1. 8/20 $\mu\text{s}$  Pulse Waveform**



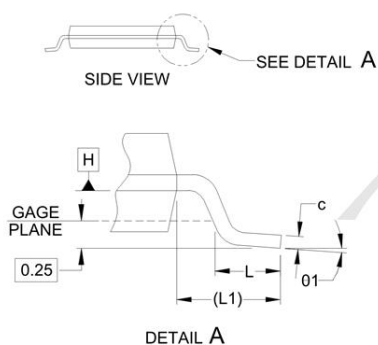
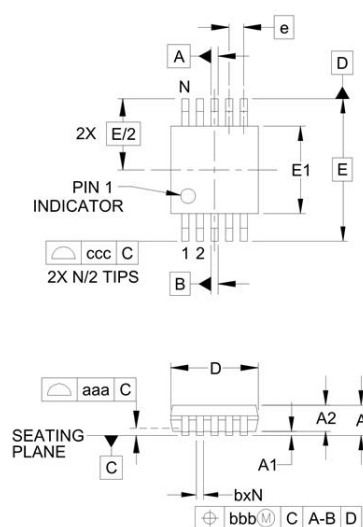
**Fig2. ESD Pulse Waveform (according to IEC 61000-4-2)**



**Fig3. Power Derating Curve**

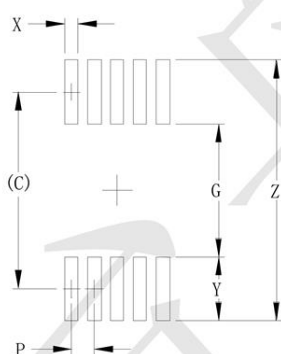


## Outline Drawing -MSOP10



DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	-	-	.043	-	-	1.10
A1	.000	-	.006	0.00	-	0.15
A2	.030	-	.037	0.75	-	0.95
b	.007	-	.011	0.17	-	0.27
c	.003	-	.009	0.08	-	0.23
D	.114	.118	.122	2.90	3.00	3.10
E	.114	.118	.122	2.90	3.00	3.10
E1	.193	BSC		4.90	BSC	
e	.020	BSC		0.50	BSC	
L	.016	.024	.032	0.40	0.60	0.80
L1		(.037)			(.95)	
N	10			10		
01	0°	-	8°	0°	-	8°
aaa		.004			0.10	
bbb		.003			0.08	
ccc		.010			0.25	

## Land Pattern -MSOP-10



DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.161)	(4.10)
G	.098	2.50
P	.020	0.50
X	.011	0.30
Y	.063	1.60
Z	.224	5.70